

P-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ)		
- 60	0.053 at V _{GS} = - 10 V	- 25	26		
- 60	0.062 at V_{GS} = - 4.5 V	- 20	20		

TO-251

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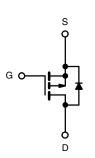
G D S Top View

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- High Side Switch for Full Bridge Converter
- DC/DC Converter for LCD Display



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A =$	= 25 °C, unless otherw	vise note)			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	- 60	v	
Gate-Source Voltage	V _{GS}	± 20	v		
Continuous Drain Current (T ₁ = 150 °C)	T _C = 25 °C	1-	- 25		
Continuous Drain Current (1) = 150°C)	T _C = 125 °C	- I _D	- 20	•	
Pulsed Drain Current		I _{DM}	- 100	- A	
Avalanche Current, Single Pulse	L = 0.1 mH	I _{AS}	- 22		
Repetitive Avalanche Energy, Single Pulse ^a		E _{AS}	24.2	mJ	
Dewar Dissinction	T _C = 25 °C	P _D	38.5 ^c	w	
Power Dissipation	T _A = 25 °C		2.3 ^{b, c}	V	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marine hurstien to Anabiento	t ≤ 10 s	R _{thJA}	17	21	°C/W
Maximum Junction-to-Ambient ^D	Steady State		45	55	
Maximum Junction-to-Case		R _{thJC}	2.7	3.25	
Notes:					

a. Duty cycle \leq 1 %.

b. When mounted on 1" square PCB (FR-4 material).

c. See SOA curve for voltage derating.

d. Based up on $T_C = 25$ °C.







Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit	
Static	•	•		•			
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I_D = - 250 μ A	- 60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			- 50	μA	
		V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 150 ° C			- 125	5	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 30			А	
		V _{GS} = - 10 V, I _D = - 10 A		0.053 0.060			
Durin Course On Chata Desistence	Beau	V_{GS} = - 10 V, I _D = - 10 A, T _J = 125 °C			0.102		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = - 10 V, I _D = - 10 A, T _J = 150 °C			0.120	Ω	
		V _{GS} = - 4.5 V, I _D = - 5 A		0.062	0.070		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 10 A		22		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1140	1710	pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = - 25 V, f = 1 MHz		130			
Reverse Transfer Capacitance	C _{rss}			90			
Total Gate Charge ^c	Qg			26	40		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -10$ A		4.5		nC	
Gate-Drain Charge ^c	Q _{gd}			7		-	
Gate Resistance	Rg	f = 1 MHz		7		Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	15		
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, \text{ R}_{L} = 3 \Omega$		9	15		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 19 Å, V_{GEN} = - 10 V, R_g = 2.5 Ω		65	100	- ns	
Fall Time ^c	t _f	1		30	45		
Drain-Source Body Diode and Charact	eristics (T _C = 2	5 °C) ^b					
Continuous Current	I _s				- 30		
Pulsed Current	I _{SM}				- 30	A	
Forward Voltage ^a	V _{SD}	I _F = - 19 A, V _{GS} = 0 V		- 1	- 1.5	V	
Reverse Recovery Time	t _{rr}	I _F = - 19 A, di/dt = 100 A/μs		41	61	ns	

Notes:

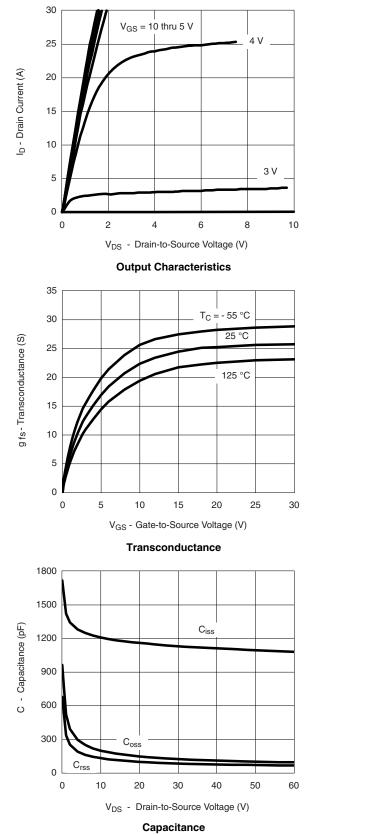
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

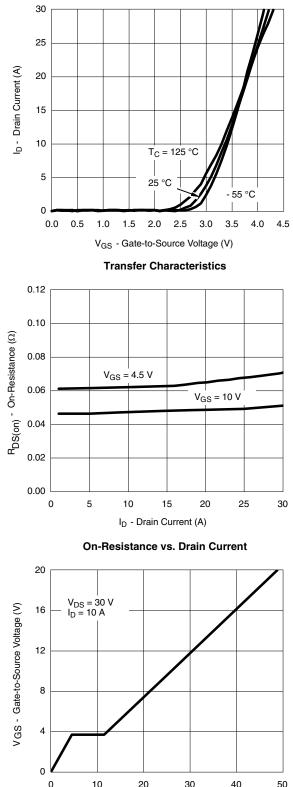
c. Independent of operating temperature.

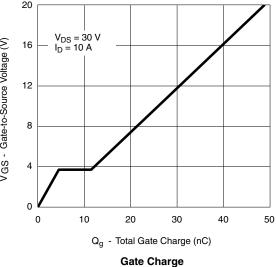
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



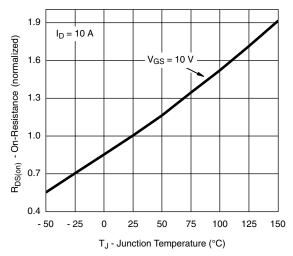


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

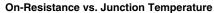




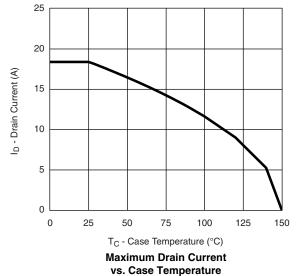


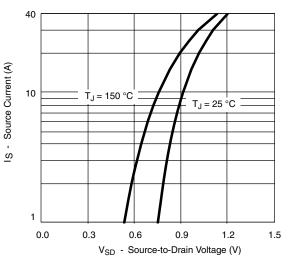


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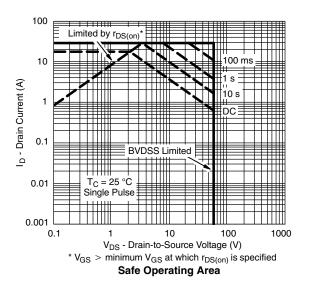


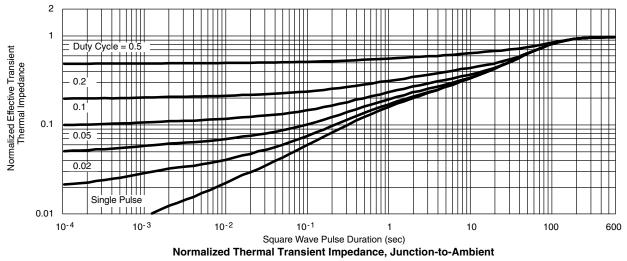






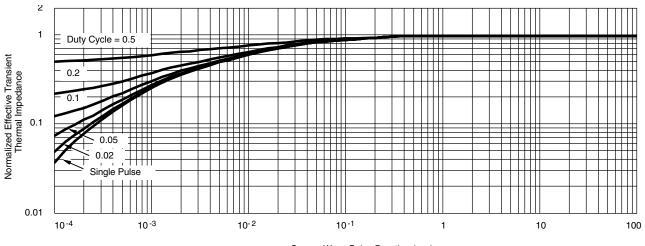
Source-Drain Diode Forward Voltage







THERMAL RATINGS

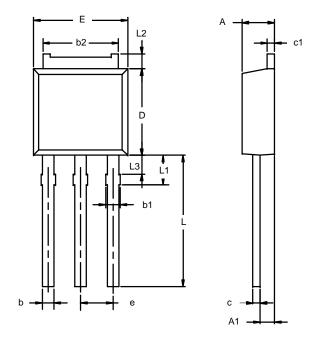


Square Wave Pulse Duration (sec)

Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA



	MILLIN	IETERS	INC	HES
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
A1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
c1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
Е	6.48	6.73	0.255	0.265
е	2.28 BSC		0.090 BSC	
L	3.89	9.53	0.153	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060
ECN: S-0 DWG: 53	3946—Rev. E 346	, 09-Jul-01		

Note: Dimension L3 is for reference only.



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